## APPLICATION DATA SHEET

APPLICATION INFORMATION

Application Type:: REGULAR Subject Matter:: UTILITY NONE

CD-ROM or CD-R?::

Title·· HIGH FREQUENCY FLIP CHIP MODULE AND

ASSEMBLING METHOD THEREOF

214306US2RD Attorney Docket Number:: 21

Total Drawing Sheets:: Small Entity?:: NO

INVENTOR INFORMATION

Inventor Authority Type:: INVENTOR

Primary Citizenship Country:: Japan

Status:: FULL CAPACITY

Yuii Given Name::

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City of Residence:: Kanaqawa Japan Country of Residence::

Street:: c/o Intellectual Property Division,

Toshiba Corporation, 1-1, Shibaura 1-chome

Minato-ku City:: Tokvo

State or Province:: Country:: Japan

Inventor Authority Type:: INVENTOR Primary Citizenship Country:: Japan

Status:: FULL CAPACITY

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Country::

Inventor Authority Type:: INVENTOR Primary Citizenship Country:: Japan

Status:: FULL CAPACITY Keiichi

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Japan Country::

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 22850

REPRESENTATIVE INFORMATION

22850 Representative Customer Number::

FOREIGN PRIORITY INFORMATION

Japan Country::

Application Number:: 2000-294053 09/27/00

Filing Date::

ASSIGNMENT INFORMATION

Country::

KABUSHIKI KAISHA TOSHIBA Assignee Name::

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